

ABSOLUTE MAXIMUM RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Input Supply Voltage		V <sub>IN</sub>	15	V		
Recommend Operation Input Supply Volta	ge	V <sub>IN (Opr. Typ.)</sub>	12	V		
Power Dissipation (Note 2)		P <sub>D</sub>	Internal limited			
Operating Temperature Range		T <sub>OPER</sub>	-40 ~ +125	°C		
Junction Temperature Range		T <sub>J</sub>	+150	°C		
Storage Temperature Range		T <sub>STG</sub>	-65 ~ +150	°C		
L C-1-1	TO-252			_		
Lead Soldering Temperature (260°C)	SOT-223		5	S		

THERMAL PERFORMANCE					
DADAMETER	CAMBOI	LIN			
PARAMETER	SYMBOL	SOT-223 TO-2		UNIT	
Junction to Ambient Thermal Resistance	R <sub>OJA</sub>	130	105	°C/W	

**Notes:**  $R_{\Theta JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistances. The case thermal reference is defined at the solder mounting surface of the drain pins.  $R_{\Theta JA}$  is guaranteed by design while  $R_{\Theta CA}$  is determined by the user's board design.  $R_{\Theta JA}$  shown below for single device operation on FR-4 PCB in still air.

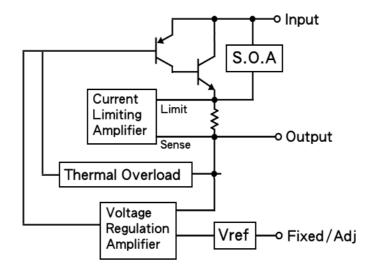
ELECTRICAL SPECIFICATIONS (T <sub>A</sub> =25°C, unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	TYP	MAX	UNIT
Reference Voltage	$V_{IN} = 2.75, I_{O} = 1A$	$V_{REF}$	1.225	1.25	1.275	V
Output Voltage (Note 4)	$V_{IN} = 2.7V \sim 12V, I_{O} = 1A$	V <sub>OUT</sub>	1.176	1.2	1.224	V
	$V_{IN} = 3V \sim 12V, I_{O} = 1A$		1.470	1.5	1.530	
	$V_{IN} = 4V \sim 12V, I_{O} = 1A$		2.450	2.5	2.550	
	$V_{IN} = 4.8V \sim 12V, I_{O} = 1A$		3.235	3.3	3.366	
	$V_{IN} = 6.5V \sim 12V, I_{O} = 1A$		4.900	5.0	5.100	
Line Regulation	$V_{O} + 1.5V \le V_{IN} \le 12V, I_{O} = 10mA$	REG <sub>LINE</sub>		0.2	0.5	%
Load Regulation (Note 1,2)	$V_{IN} = V_{OUT} + 1.5V$ , $I_{O} = 10 \text{mA} \sim 1 \text{A}$	REG <sub>LOAD</sub>		0.05	1.0	%
Dropout Voltage	$I_O = 1A$ , $\Delta V_{OUT} = 1\% V_{OUT}$	$V_{DROP}$		1.3	1.5	V
Quiescent Current	V <sub>IN</sub> = 5V	IQ		5	10	mA
Adjustable Pin Current		I <sub>ADJ</sub>		90		μA
Output Current Limit	$V_{IN}$ - $V_{OUT}$ = 1.5 $V$	I <sub>LIMIT</sub>	1.1			Α
Temperature Stability	I <sub>O</sub> =10mA,			0.5		%
Ripple Rejection	f= 120Hz, I <sub>O</sub> = 1A, C <sub>OUT</sub> =25μF,	RR		60	70	dB
Mata.	$V_{IN} = V_{OUT} + 3V$					

#### Note:

- 1. See thermal regulation specification for changes in output voltage due to heating effects. Line and load regulation are measured at a constant junction temperature by low duty cycle pulse testing. Load regulation is measured at the output lead = 1/18" from the package.
- 2. Line and load regulation are guaranteed up to the maximum power dissipation of 15W. Power dissipation is determined by the input / output voltage difference and the output current. Guaranteed maximum power dissipation will not be available over the full input / output voltage range.
- 3. Quiescent current is defined as the minimum output current required to maintain the regulation.
- 4. The Output Capacitor does not have a theoretical upper limit and increasing its value will increase stability.  $C_{OUT}$ =100uF or more is typical for high current regulator design.



## **FUNCTION BLOCK**



## **ORDERING INFORMATION**

OUTPUT VOLTAGE	PART NO.	PACKAGE	PACKING
ADJ	TS1117BCP ROG	TO-252 (DPAK)	2,500pcs / 13" Reel
	TS1117BCW RPG	SOT-223	2,500pcs / 13" Reel
1.2V	TS1117BCW12 RPG	SOT-223	2,500pcs / 13" Reel
2.5V	TS1117BCW25 RPG	SOT-223	2,500pcs / 13" Reel
3.3V	TS1117BCP33 ROG	TO-252 (DPAK)	2,500pcs / 13" Reel
	TS1117BCW33 RPG	SOT-223	2,500pcs / 13" Reel
5V	TS1117BCP50 ROG	TO-252 (DPAK)	2,500pcs / 13" Reel
	TS1117BCW50 RPG	SOT-223	2,500pcs / 13" Reel

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#### **CHARACTERISTICS CURVES**

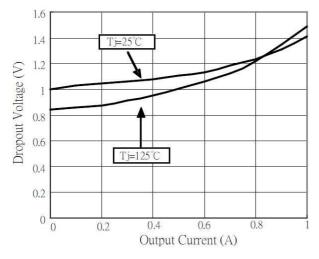


Figure 1. V<sub>DROP</sub> vs. Output Current

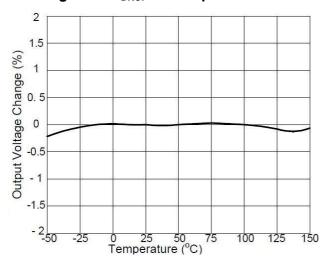


Figure 3. V<sub>OUT</sub> Change vs. Temperature

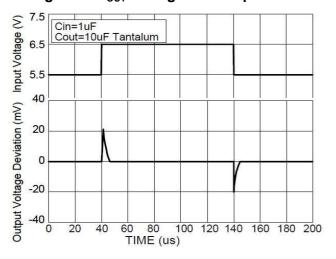


Figure 5. Line Transient Response

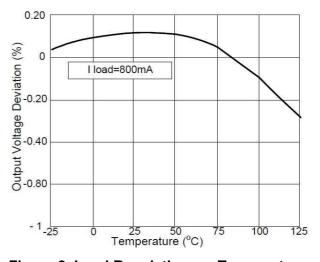


Figure 2. Load Regulation vs. Temperature

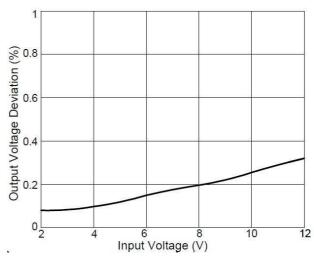


Figure 4. V<sub>OUT</sub> Deviation vs. Temperature

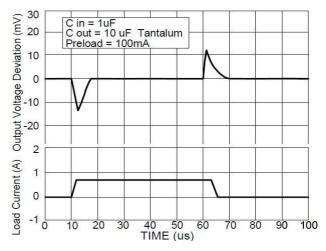
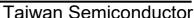
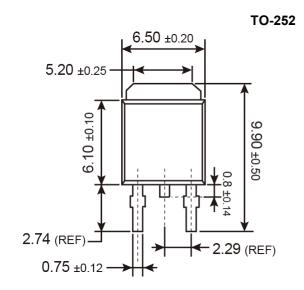


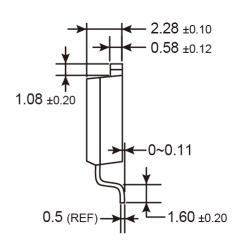
Figure 6. Load Transient Response



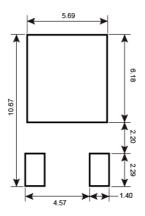


## PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)



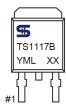


#### **SUGGESTED PAD LAYOUT**



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## **MARKING DIAGRAM**



Y = Year Code

M = Month Code for Halogen Free Product

O =Jan P =Feb Q =Mar R =Apr

S =May T =Jun U =Jul V =Aug

W = Sep X = Oct Y = Nov Z = Dec

L = Lot Code

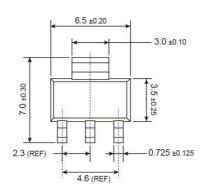
**XX** = Output Voltage Code (**3.3**=3.3V, **5.0**=5V)

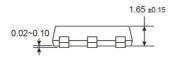
= CP for Adjustable output voltage version

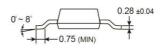


## PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

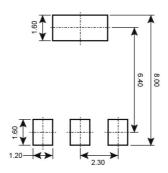
#### **SOT-223**







## SUGGESTED PAD LAYOUT (Unit: Millimeters)



#### **MARKING DIAGRAM**



Y = Year Code

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O =Jan P =Feb Q =Mar R =Apr S =May T =Jun U =Jul V =Aug W =Sep X =Oct Y =Nov Z =Dec

L = Lot Code

**XX** = Output Voltage Code (**1.2**=1.2V, **2.5**=2.5V, **3.3**=3.3V, **5.0**=5V)

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= CW for Adjustable output voltage version



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